

PATENT ASSIGNMENT COVER SHEET

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 Stylesheet Version v1.2

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
JAN SCICINSKI	02/07/2017
WILLIAM VAN OSDOL	02/06/2017
HUEY CHING SU	02/15/2017
MICHAEL ARENBERG	02/15/2017
JAYMIN SHAH	02/22/2017
RECEIVING PARTY DATA	
Name:	DURECT CORPORATION
Street Address:	10260 BUBB ROAD
City:	CUPERTINO
State/Country:	CALIFORNIA
Postal Code:	95014
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15853013
CORRESPONDENCE DATA	
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<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
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ATTORNEY DOCKET NUMBER:	DURE-073CON4
NAME OF SUBMITTER:	MICHAEL B. RUBIN
SIGNATURE:	/Michael B. Rubin, Reg. No. 61,231/
DATE SIGNED:	01/30/2019
Total Attachments: 4	
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ASSIGNMENT

For good and valuable consideration, receipt of which is hereby acknowledged,
we

<u>Jan Scicinski</u>	of	<u>Saratoga, CA</u>	;
<u>William van Osdol</u>	of	<u>Mountain View, CA</u>	;
<u>Huey Ching Su</u>	of	<u>San Jose, CA</u>	;
<u>Michael Arenberg</u>	of	<u>Campbell, CA</u>	;
<u>Jaymin Shah</u>	of	<u>Sunnyvale, CA</u>	.

Are the inventors of the invention in:

ORAL PHARMACEUTICAL DOSAGE FORMS

For which we filed a United States Patent Application on 07/02/2015, and now has
Serial No. 14/791,073;

And WHEREAS, Durect Corporation, a Delaware Corporation, having a place of
business at: 10260 Bubb Road, Cupertino, California, 95014, is desirous of obtaining the
entire right, title and interest in, to and under the said invention and the said application.

NOW, THEREFORE, we, the said ASSIGNORS, do hereby sell, assign, transfer and set
over, unto the said ASSIGNEE, its successors, legal representatives and assigns, the
entire right, title, and interest in, to and under the said invention, and the said United
States application and all provisionals, divisionals, renewals and continuations thereof;
and all Patents of the United States which may be granted thereon and all reissues and
extensions thereof and all applications for industrial property protection, including,
without limitation, all applications for patents, utility models, and designs which may
hereafter be filed for said inventions in any country or countries foreign to the United
States, together with the right to file such applications and the right to claim for the same
priority rights derived from said United States application under the Patent Laws of the
United States, the International Convention for the Protection of Industrial Property, or
any other international agreement or the domestic laws of the country in which any such
application is filed, as may be applicable; and all forms of industrial property protection,
including, without limitation, patents, utility models, inventors' certificates and designs
which may be granted for said invention in any country or countries foreign to the
United States and all extensions, renewals and reissues thereof.

AND WE HEREBY authorize and request the Commissioner of Patents and Trademarks
of the United States, and any Official of any country or countries foreign to the United
States, whose duty it is to issue patents of other evidence of forms of industrial property
protection on applications as aforesaid, to issue the same to the said ASSIGNEE, its

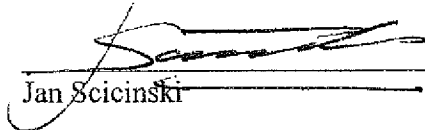
successors, legal representatives and assigns, in accordance with the terms of this instrument.

AND WE HEREBY covenant and agree that we have full right to convey the entire interest herein assigned, and that we have not executed, and will not execute, any agreement in conflict herewith.

AND WE HEREBY further covenant and agree that we will communicate to the said ASSIGNEE, its successors, legal representatives and assigns, any facts known to us respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing, reissue and foreign applications, make all rightful oaths and generally do everything possible to aid the said ASSIGNEE, its successors, legal representatives and assigns, to obtain and enforce proper protection for said invention in all countries.

IN TESTIMONY WHEREOF, WE hereunto set our hands and seals the day and year set opposite our respective signatures.

Executed this 7 day of Feb, 2017



Jan Scicinski

Executed this ____ day of _____, 2017

William van Osdol

Executed this ____ day of _____, 2017

Huey Ching Su

Executed this ____ day of _____, 2017

Michael Arenberg

Executed this ____ day of _____, 2017

Jaymin Shah

Hereby accepted on behalf of the assignee:

Executed this 22nd day of February, 2017



Signature

VP, Chief Patent Counsel, Durect Corporation
Title

successors, legal representatives and assigns, in accordance with the terms of this instrument.

AND WE HEREBY covenant and agree that we have full right to convey the entire interest herein assigned, and that we have not executed, and will not execute, any agreement in conflict herewith.

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IN TESTIMONY WHEREOF, WE hereunto set our hands and seals the day and year set opposite our respective signatures.

Executed this ____ day of ____, 2017

Jan Scicinski

Executed this 6th day of February, 2017

William van Osdol

Executed this ____ day of ____, 2017

Huey Ching Su

Executed this ____ day of ____, 2017

Michael Arenberg

Executed this ____ day of ____, 2017

Jaymin Shah

Hereby accepted on behalf of the assignee:

Executed this 22nd day of February, 2017

Signature

VP, Chief Patent Counsel, Durect Corporation
Title

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IN TESTIMONY WHEREOF, WE hereunto set our hands and seals the day and year set opposite our respective signatures.

Executed this ____ day of _____, 2017

Jan Scicinski

Executed this ____ day of _____, 2017

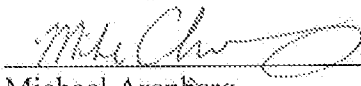
William van Osdol

Executed this 15 day of Feb, 2017



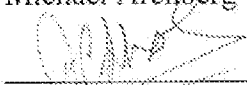
Huey Ching Su

Executed this 15 day of Feb, 2017



Michael Arenberg

Executed this 22 day of Feb, 2017



Jaymin Shah

Hereby accepted on behalf of the assignee:

Executed this 22nd day of February, 2017



Signature

VP, Chief Patent Counsel, Durect Corporation
Title